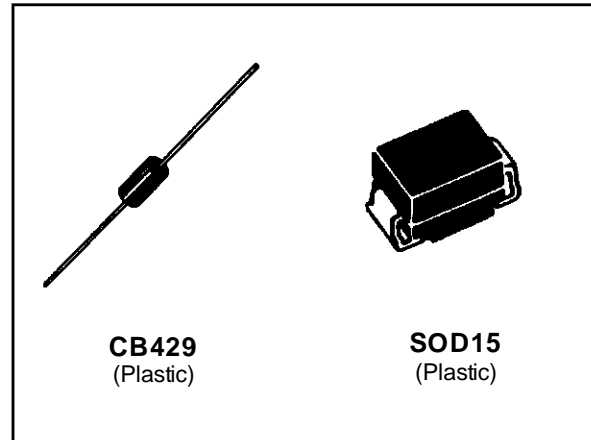


TRISIL DISCRETE SOLUTION FOR ISDN PROTECTION

FEATURES

- UNIDIRECTIONAL CROWBAR PROTECTION.
- PEAK PULSE CURRENT :
I_{PP} = 75 A , 10/1000 μs.
- HOLDING CURRENT = 150mA.
- BREAKDOWN VOLTAGE:
TPU58/SMTHDT58 = 58V.
TPU80/SMTHDT80 = 80V.
TPU120/SMTHDT120 = 120V.
- PACKAGES:
TPUxx = AXIAL DIODE.
SMTHDTxx = SURFACE MOUNT PACKAGE.



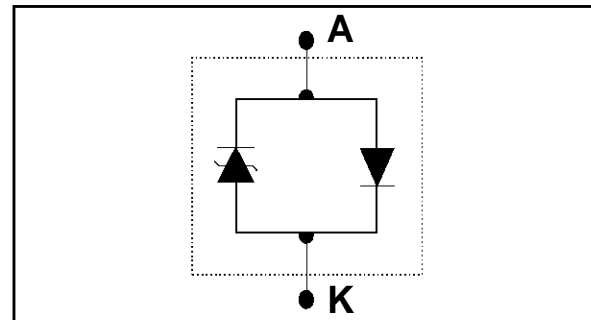
DESCRIPTION: TRIBALANCED PROTECTION

Dedicated protection devices for ISDN LINE CARD and high speed data telecom lines.

Used with the recommended configuration using 3 components, they will provide =

- Dual bidirectionnal protection, with fixed breakdown voltage in both common and differential modes.
- Low capacitances from lines to ground.
- Very good capacitance balance : ΔC= 30 pF.

FUNCTIONAL DIAGRAM.



ABSOLUTE RATINGS (limiting values) (-40°C ≤ T_{amb} ≤ +85°C)

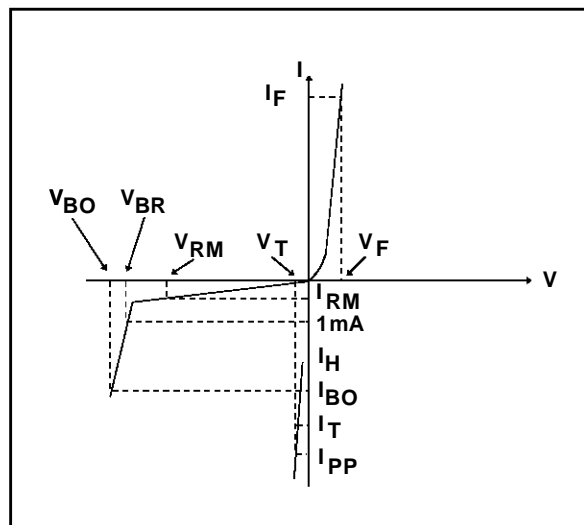
Symbol	Parameter		Value	Unit
I _{PP}	Peak pulse current	10/1000 μs 8/20 μs	75 150	A
I _{TSM}	Non repetitive surge peak on-state current	tp = 20 ms	30	A
di/dt	Critical rate of rise of on-state current	Non repetitive	100	A/μs
dv/dt	Critical rate of rise of off-state voltage	67% V _{BR}	5	KV/μs
T _{stg} T _j	Storage and operating junction temperature range		- 40 to + 150 + 150	°C °C

THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
R _{th (j-l)}	Junction-leads Thermal Resistance	CB429 SOD15	20 20	°C/W °C/W

ELECTRICAL CHARACTERISTICS

Symbol	Parameter
V_{RM}	Stand-off voltage
V_{BR}	Breakdown voltage
V_{BO}	Breakover voltage
I_H	Holding current
V_T	On-state voltage
V_F	Forward Voltage Drop
I_{BO}	Breakover current
I_{PP}	Peak pulse current



PARAMETERS RELATED TO THE DIODE.

Parameter	Test conditions	Value	Unit
V_F	$I_F = 5A, T_P = 500 \mu s$	5	V

PARAMETERS RELATED TO THE PROTECTION TRISIL.

Types	$I_R @ V_{RM}$		$V_{BR} @ I_R$		V_{BO}	I_{BO}		I_H	V_T	C
	max		min		max	min	max	min	max	max
	μA	V	V	mA	V	mA	mA	mA	V	pF
TPU58/SMTHDT58	10	56	58	1	80	150	800	150	5	400
TPU80/SMTHDT80	10	68	80	1	120	150	800	150	5	250
TPU120/SMTHDT120	10	102	120	1	180	150	800	150	5	200

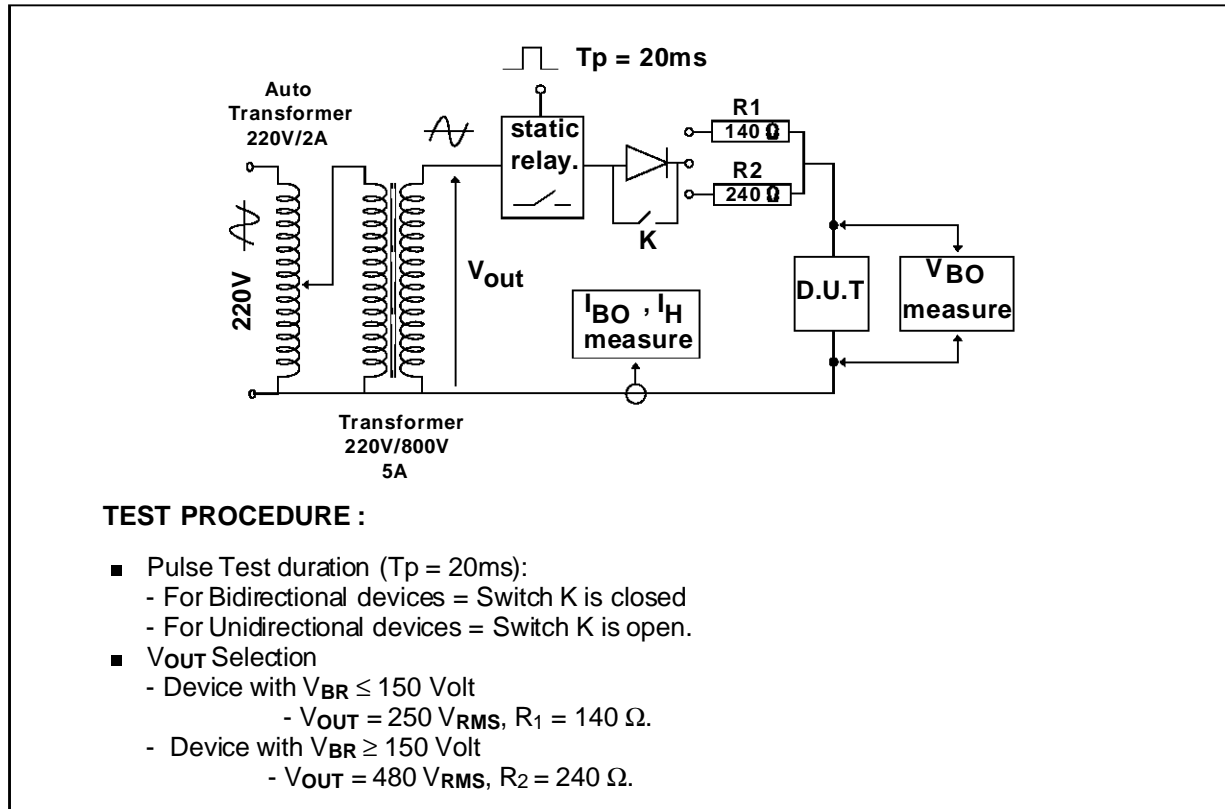
All parameters tested at 25 °C, except where indicated.

Note 1 : See the reference test circuit for I_H , I_{BO} and V_{BO} parameters.

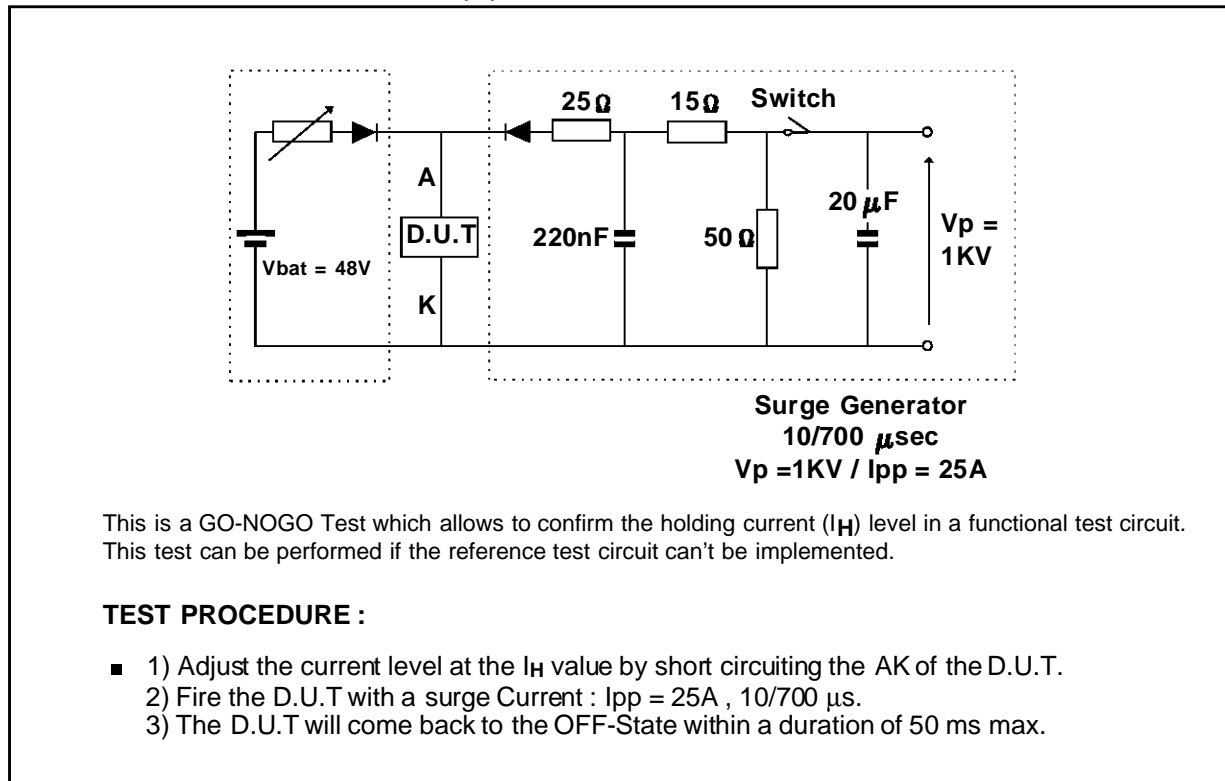
Note 2 : Square pulse $T_p = 500 \mu s - I_T = 5A$.

Note 3 : $V_R = 1V, F = 1MHz$.

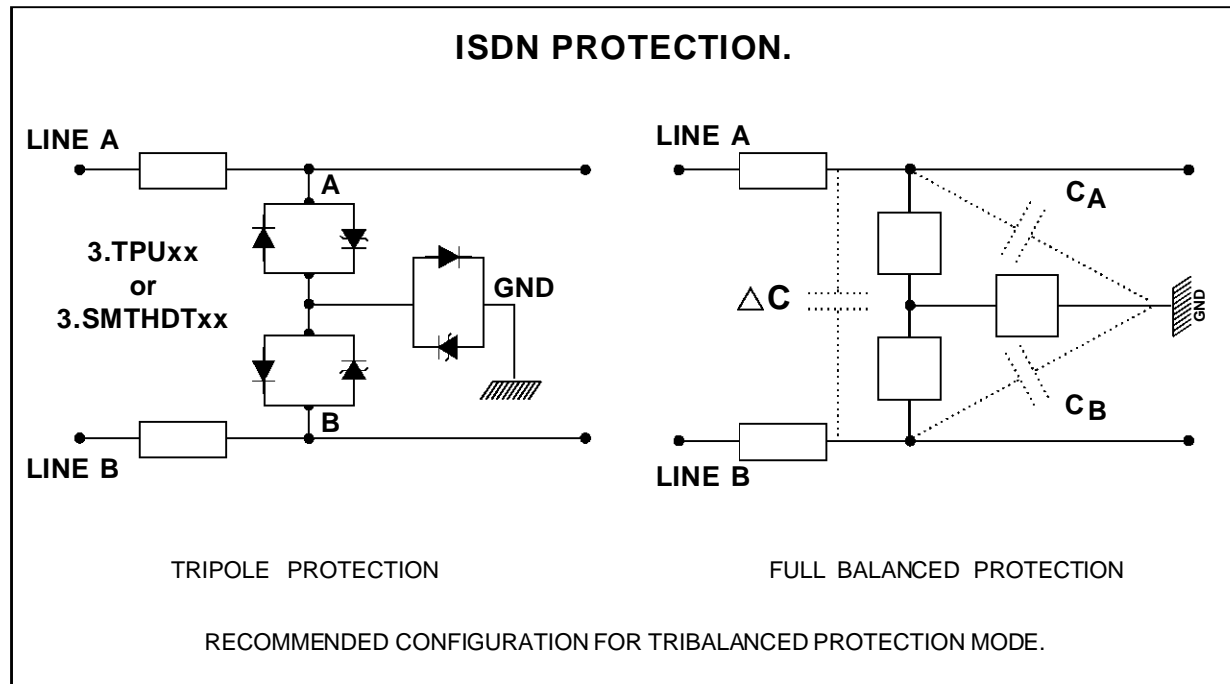
REFERENCE TEST CIRCUIT FOR I_H , I_{BO} and V_{BO} parameters :



FUNCTIONAL HOLDING CURRENT (I_H) TEST CIRCUIT = GO - NOGO TEST.



APPLICATION NOTE

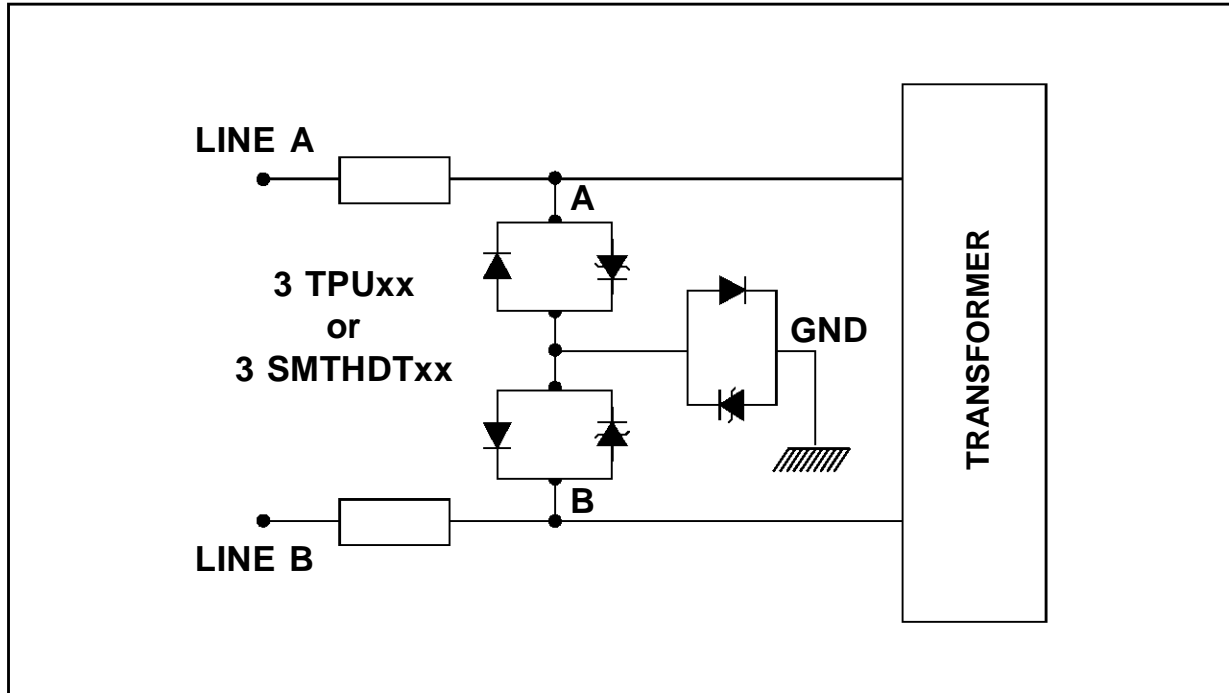


CAPACITANCE CHARACTERISTICS

Type	CONFIGURATION		C _A pF Max	C _B pF Max	ΔC pF Max
	LINE A	LINE B			
TPU58/SMTHDT58	48	0	80	60	30
TPU80/SMTHDT80	56	0	70	50	30
TPU120/SMTHDT120	110	0	70	50	30

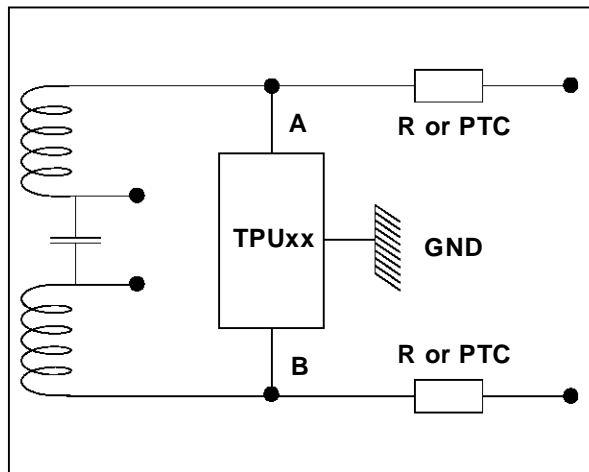
APPLICATION NOTE

Discrete ISDN Protection solution

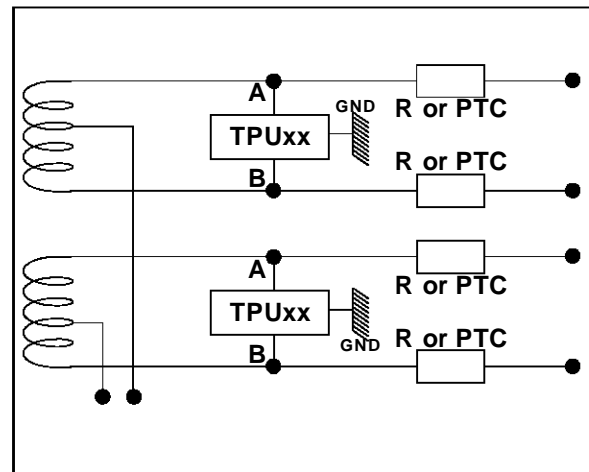


EQUIVALENT PROTECTION FUNCTION

U Interface Protection



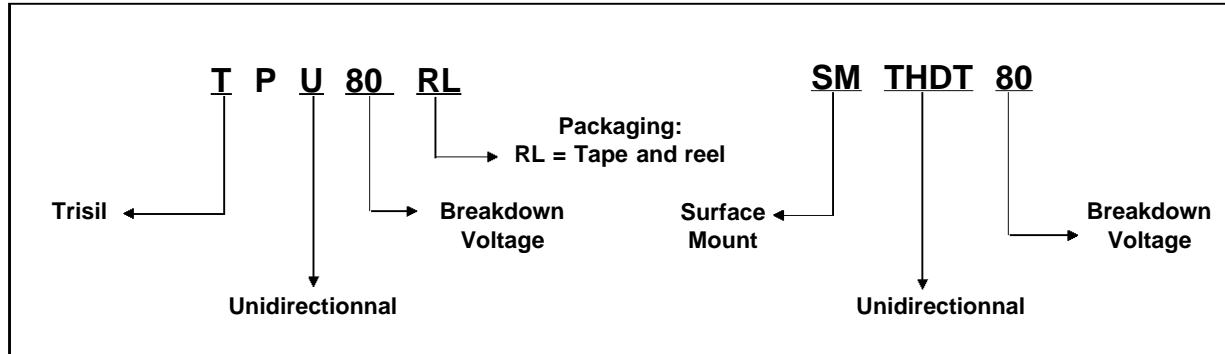
S Interface Protection



This topology assumes the same breakdown voltage level in positive and negative for differential or common mode surge.

TPUxx/SMTHDTxx

ORDER CODE



MARKING

Package	Type	Marking
CB429	TPU58	TPU58
	TPU80	TPU80
	TPU120	TPU120

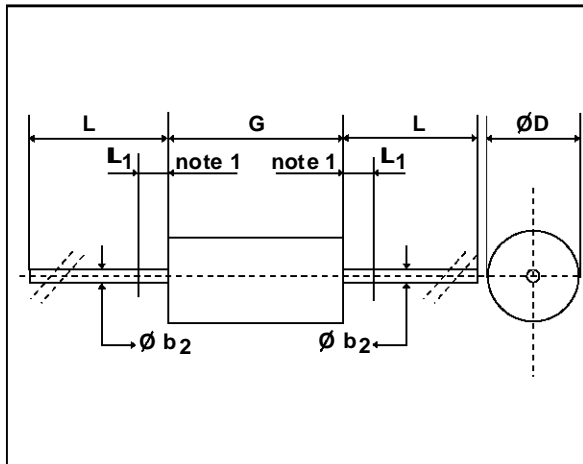
A white band indicates the cathode

Package	Type	Marking
SOD15	SMTHDT58	W01
	SMTHDT80	W03
	SMTHDT120	W05

A white band indicates the cathode

PACKAGE MECHANICAL DATA

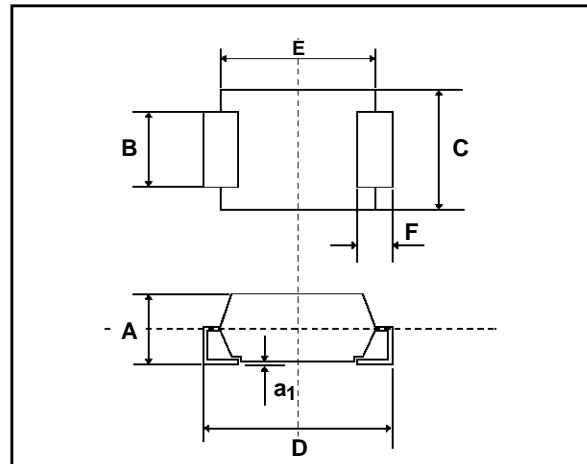
CB429



Ref	Millimeters		Inches	
	min	max	min	max
Ø b ₂	-	1.06	-	0.042
Ø D	-	5.1	-	0.20
G	-	9.8	-	0.386
L	26	-	1.024	-
L ₁	-	1.27	-	0.050

note1: The diameter Ø b₂ is not controlled over zone L₁.

SOD15



Ref	Millimeters		Inches	
	min	max	min	max
A	2.5	3.1	0.098	0.122
a ₁	-	0.2	-	0.008
B	2.9	3.1	0.114	0.122
C	4.8	5.2	0.190	0.200
D	7.6	8.0	0.300	0.315
E	6.3	6.6	0.248	0.259
F	1.3	1.7	0.051	0.067

Packaging : Axial Diode CB429 = Products Supplied in Tape and Reel.
SOD15 =Standard packaging is in Film.

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